

Appl. No. 10/695,187
Amdt. Dated November 10, 2005
Reply to Office Action of June 10, 2005

Docket No. IS01207/AP
Customer No. 22917

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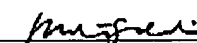
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UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT(S)	Weigler, et al.	GROUP ART UNIT:	1725
APPLN. NO.:	10/695,187	EXAMINER:	Jonathan J. Johnson
FILED:	10/28/2003	Confirmation No.	4286
TITLE:	VERTICAL REMOVAL OF EXCESS SOLDER FROM A CIRCUIT SUBSTRATE		

Date of deposit: November 10, 2005

I hereby certify that this paper is being facsimile transmitted or deposited with the United States Postal Service on the date indicated above, as first-class mail, with sufficient postage attached thereto, in an envelope addressed to Mail Stop Fee Amendment, Assistant Commissioner for Patents, Alexandria, VA 22313 or facsimile transmitted to 571-273-8300.


Signature of Person Mailing Paper

Indira Saladi
Printed Name of Person Mailing Paper

AMENDMENT

Mail Stop FEE AMENDMENT
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Office Action dated 6/10/2005, Paper No. 060805, please amend the above-identified application as follows:

Amendments to the claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 6 of this paper.